

1 Absolute maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CEO}	Collector-emitter voltage ($I_B = 0$)	80	V
V_{EBO}	Emitter-base voltage ($I_C = 0$)	5	V
I_C	Collector current	10	A
I_{CM}	Collector peak current	20	A
P_{TOT}	Total dissipation at $T_{case} = 25\text{ °C}$	50	W
T_{STG}	Storage temperature	-55 to 150	°C
T_J	Max. operating junction temperature	150	°C

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-case max	2.5	°C/W
R_{thJA}	Thermal resistance junction-ambient max	62.5	°C/W

2 Electrical characteristics

$T_{\text{case}} = 25\text{ }^{\circ}\text{C}$; unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{\text{CEO(sus)}}^{(1)}$	Collector-emitter sustaining voltage ($I_B = 0$)	$I_C = 30\text{ mA}$	80	-		V
I_{CES}	Collector cut-off current ($V_{\text{BE}} = 0$)	$V_{\text{CE}} = 80\text{ V}$		-	10	μA
I_{EBO}	Emitter cut-off current ($I_C = 0$)	$V_{\text{EB}} = 5\text{ V}$		-	50	μA
$V_{\text{CE(sat)}}^{(1)}$	Collector-emitter saturation voltage	$I_C = 8\text{ A}$ $I_B = 0.4\text{ A}$		-	1	V
$V_{\text{BE(sat)}}^{(1)}$	Base-emitter saturation voltage	$I_C = 8\text{ A}$ $I_B = 0.8\text{ A}$		-	1.5	V
$h_{\text{FE}}^{(1)}$	DC current gain	$I_C = 2\text{ A}$ $V_{\text{CE}} = 1\text{ V}$	60	-		
		$I_C = 4\text{ A}$ $V_{\text{CE}} = 1\text{ V}$	40	-		

1. Pulse test: pulse duration $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

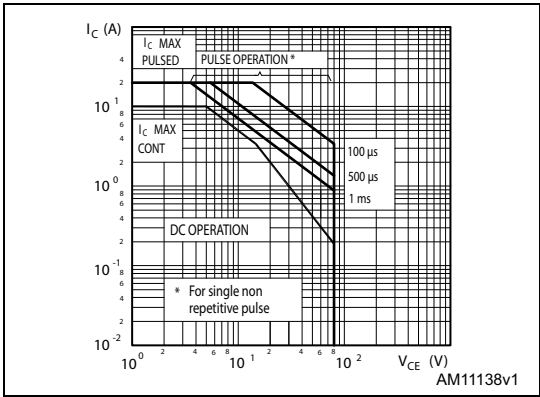


Figure 3. Derating curve

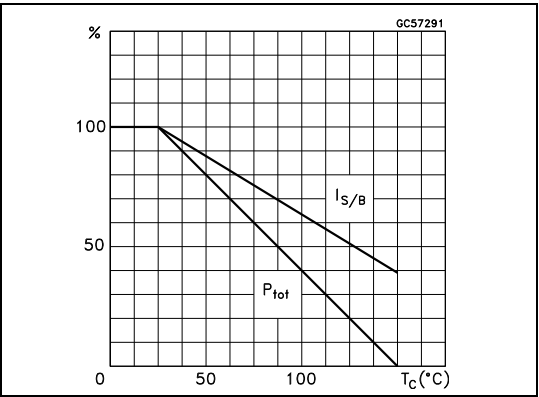


Figure 4. DC current gain

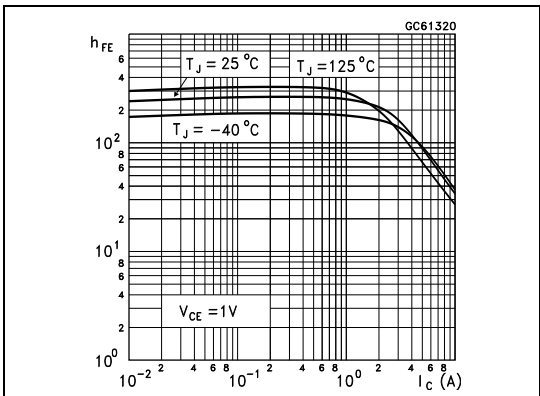
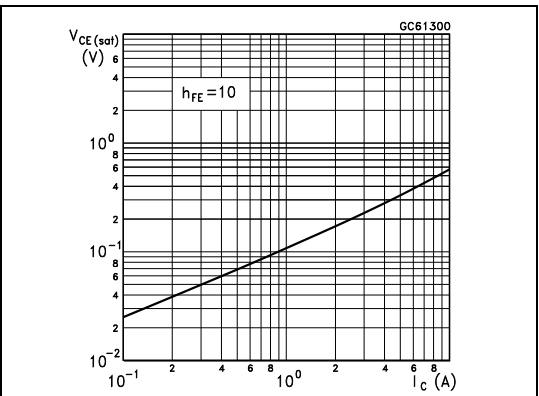


Figure 5. Collector-emitter saturation voltage



3 Package mechanical data

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Figure 6. D²PAK (TO-263) drawing

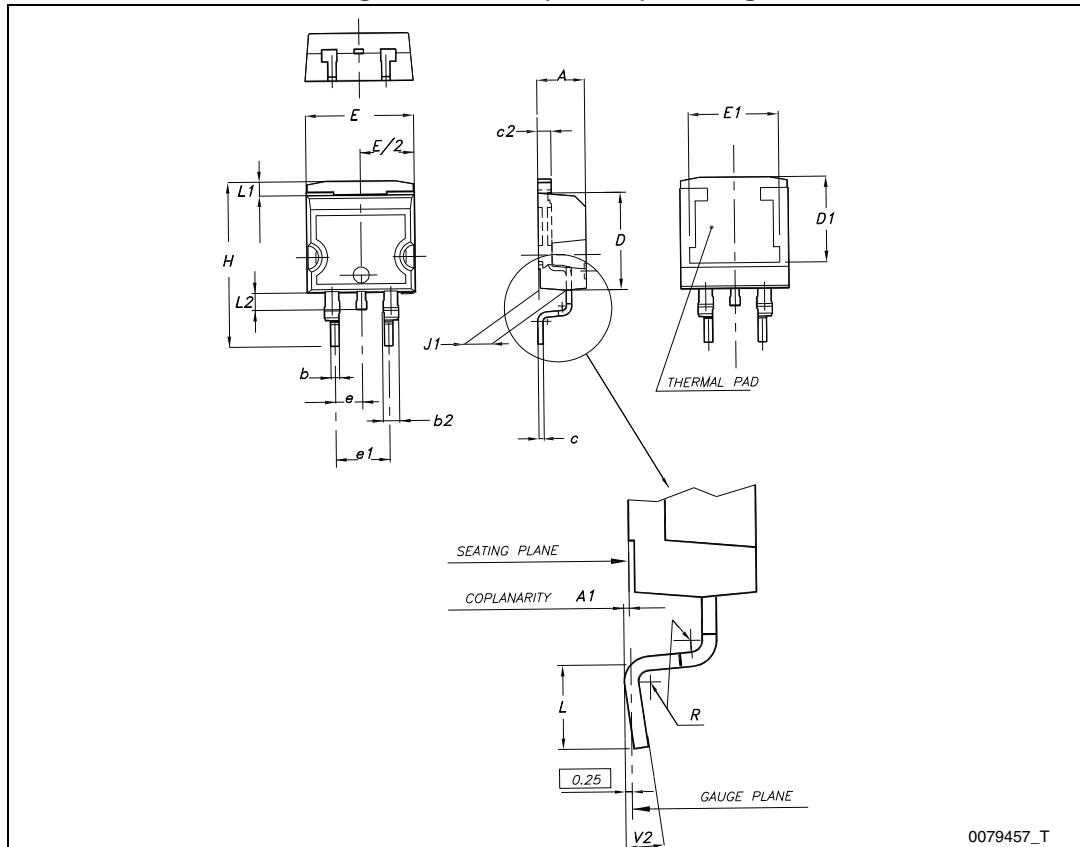
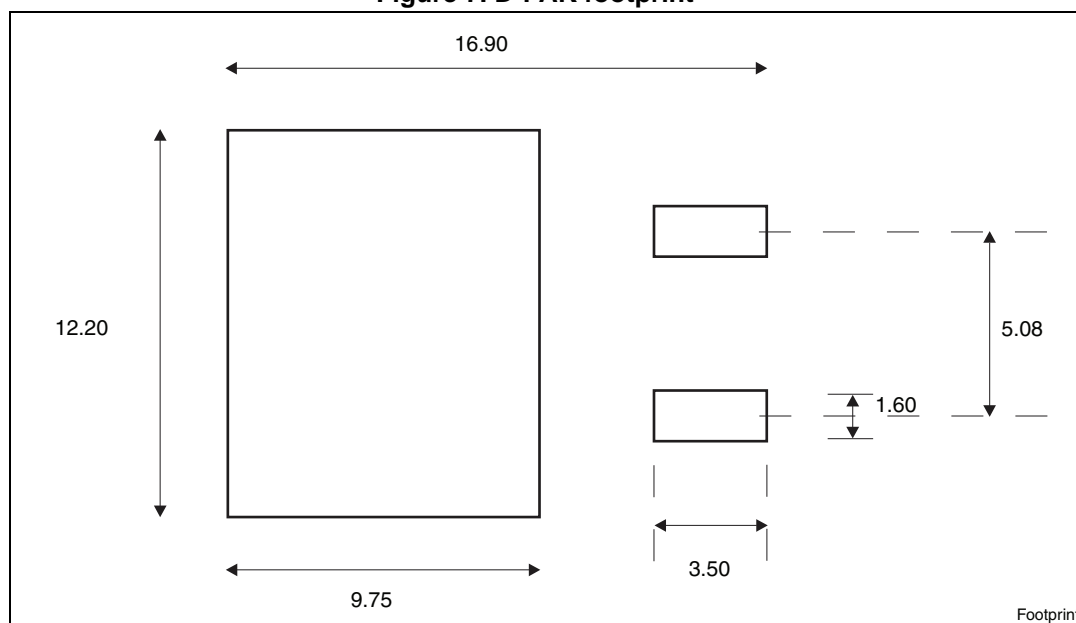


Table 5. D²PAK (TO-263) mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
c	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50		
E	10		10.40
E1	8.50		
e		2.54	
e1	4.88		5.28
H	15		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.4	
V2	0°		8°

Figure 7. D²PAK footprint^(a)

a. All dimension are in millimeters

4 Packaging mechanical data

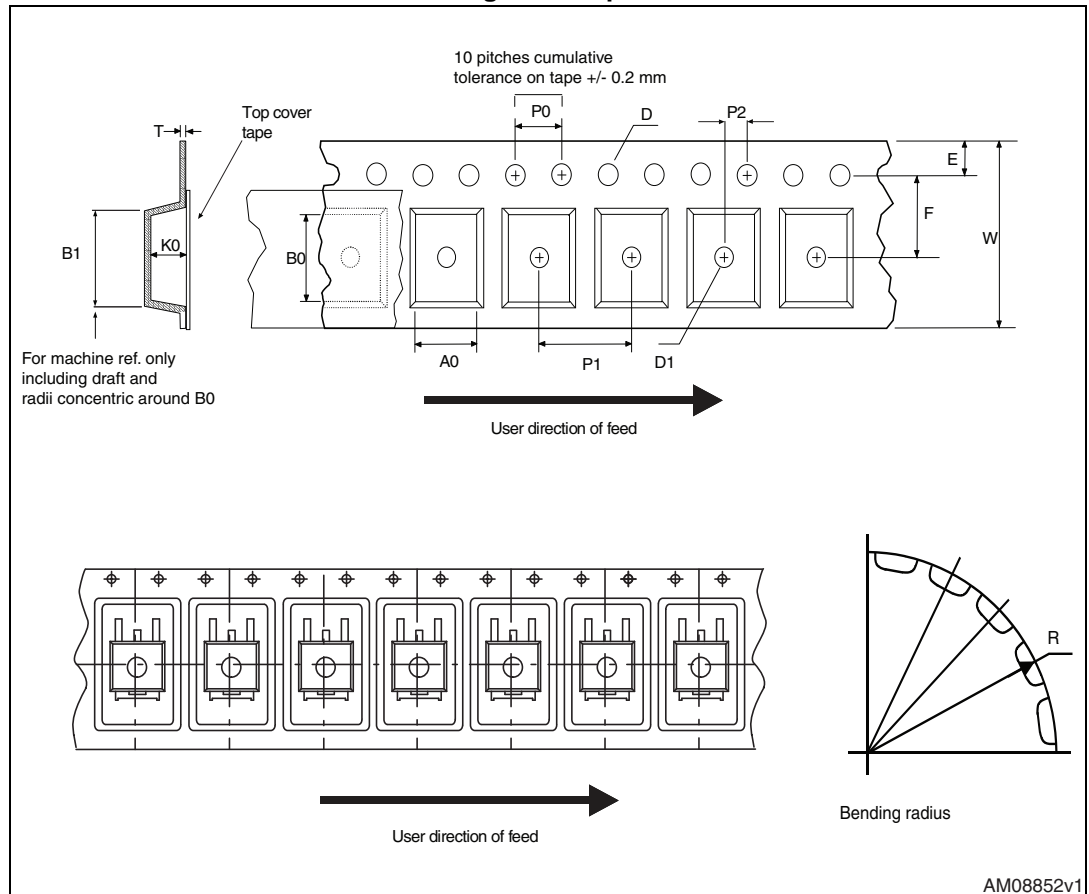
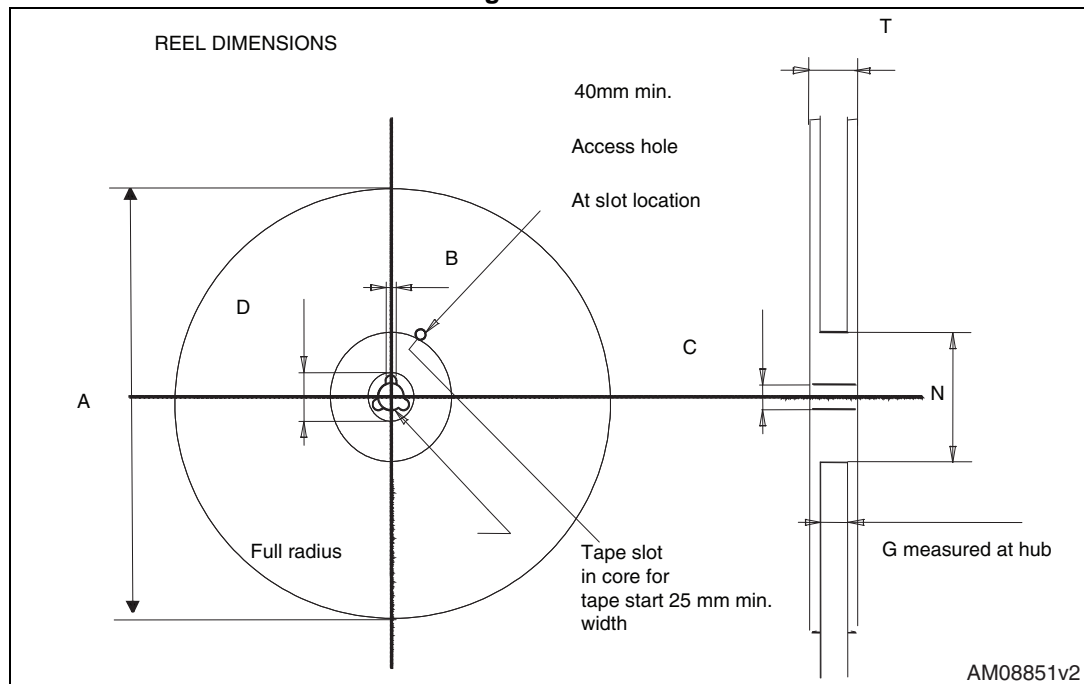
Figure 8. Tape

Figure 9. Reel

Table 6. D²PAK (TO-263) tape and reel mechanical data

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	10.5	10.7	A		330
B0	15.7	15.9	B	1.5	
D	1.5	1.6	C	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	T		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base qty		1000
P2	1.9	2.1	Bulk qty		1000
R	50				
T	0.25	0.35			
W	23.7	24.3			

5 Revision history

Table 7. Document revision history

Date	Revision	Changes
23-Jan-2012	1	Initial release.
12-May-2014	2	Updated Section 3: Package mechanical data . Added Section 4: Packaging mechanical data .

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